

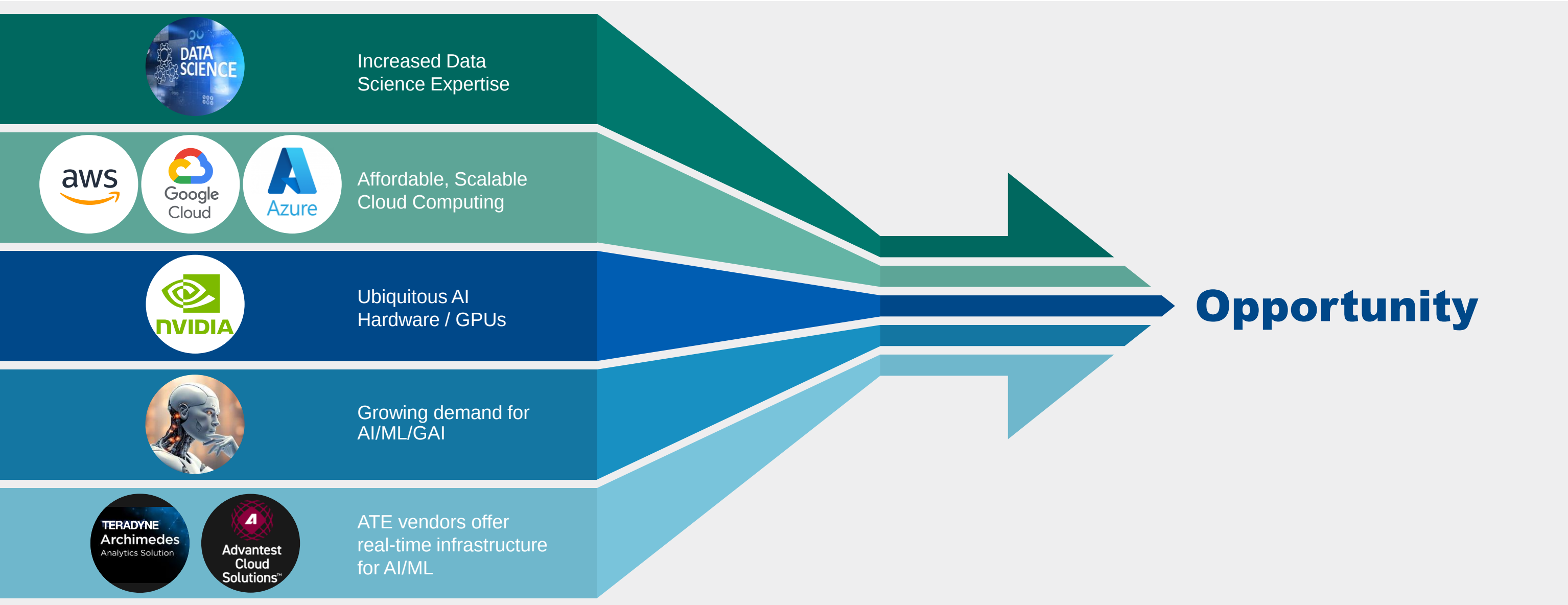
connext

Implementing Real-time AI in High-Volume Test

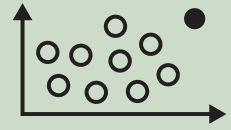
Michael Schuldenfrei, NI Fellow
Michael.Schuldenfrei@ni.com



Converging Trends Creating an Opportunity



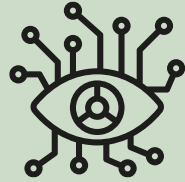
Edge (and Cloud) AI Examples



Outlier detection
(Advanced)



Escape prevention
(Equipment Health etc.)



Optical defect detection
/ ROI quality (e.g.,
welds, soldering etc.)



RMA reduction /
prediction



Parametric trend
detection



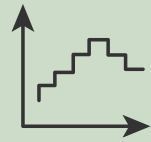
Parametric insights



Scratch detection
(wafers)



AI based RCA



Waveform anomaly
detection



Battery analytics
(capacity, smart pairing,
etc.)



Process optimization
(e.g., Adaptive
manufacturing)



Early failure detection



Next operation reduction



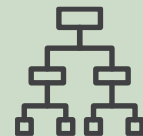
Monitoring and auto
RCA (UPH, cycle time,
yield, error code
distributions etc.)



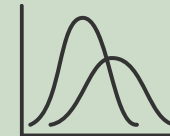
Process variation
detection



Yield trend detection



Wafer classification



Equipment
utilization/variations

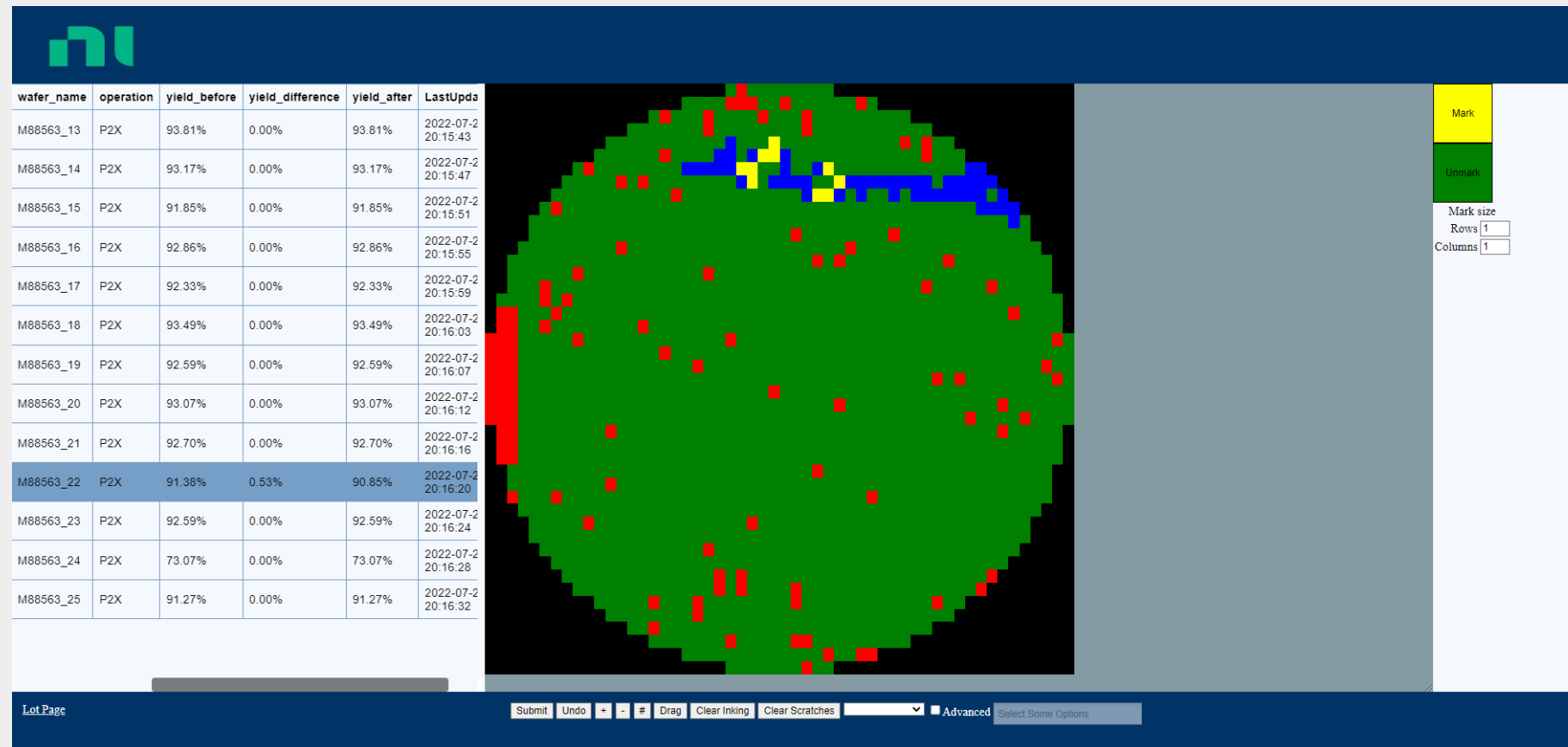


Predictive / JIT
maintenance



Test (program)
comparison

Scratch Detection

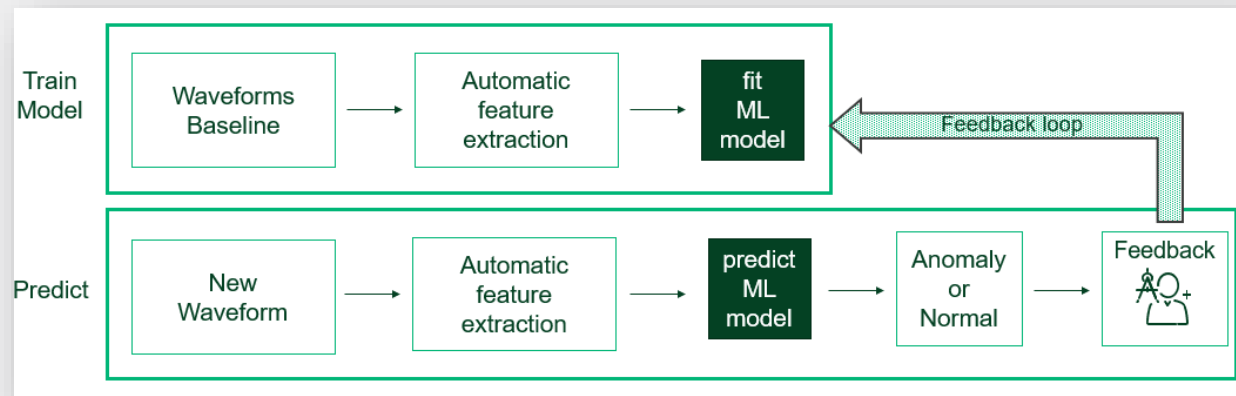


- Uses deep learning (DL) algorithms to detect scratches
- Automatically suggests inking – scraps suspect dies around the scratch
- Improves over time given user feedback

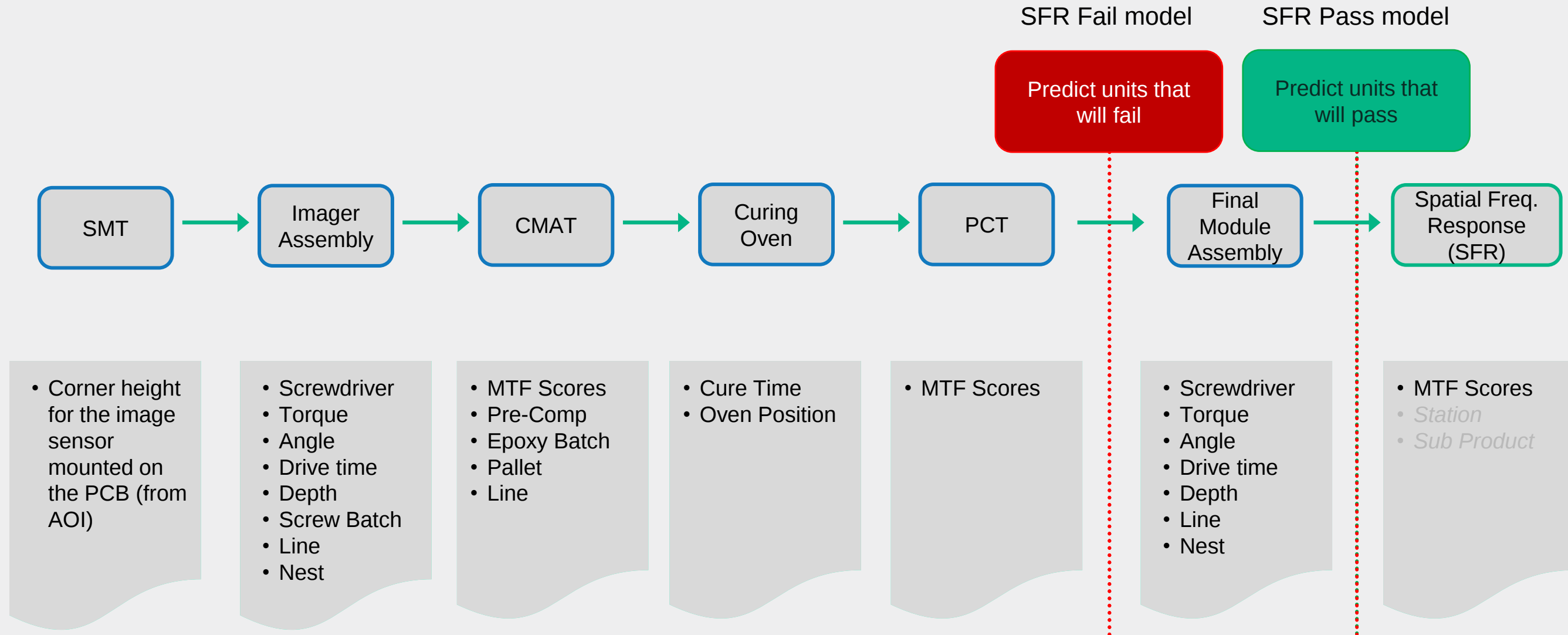
Preventative Maintenance Using Waveforms

AI-based alerting on anomalies

- **Multivariate**
Holistic view of the waveform
- **Minimal configuration**
Automatic identification and extraction of relevant features
- **Feedback loop**
Improves with user feedback



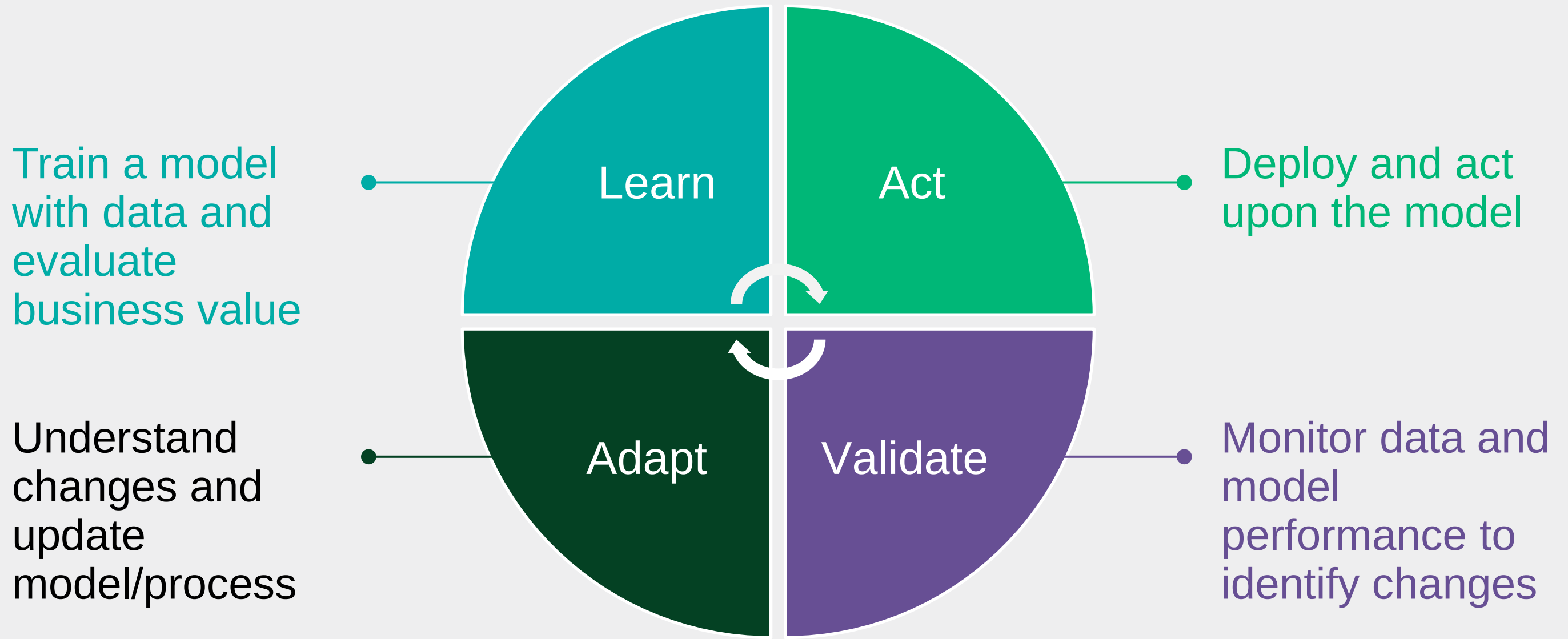
Next Operation Optimization / Lean Coverage



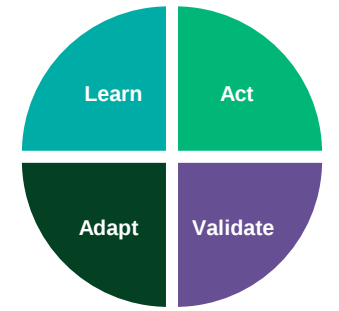
Implementing AI at the Edge

It sounds like a great idea – what's preventing
it from happening?

The Full Machine Learning Lifecycle



ML Challenges



Learn

- **Getting data**
Data scientists waste time getting and organizing data
- **Feature extraction**
It is difficult to extract complex features from the data set
- **Freedom of choice**
Data scientists want to use their favorite tools and the latest-and-greatest algorithms

Act

- **Complex “plumbing”**
Data scientists waste time dealing with the “plumbing” associated with getting a model into production
- **Actionability**
Taking action requires integration with equipment and systems
- **Distributed mfg.**
Issues compounded in distributed, outsourced mfg.

Validate

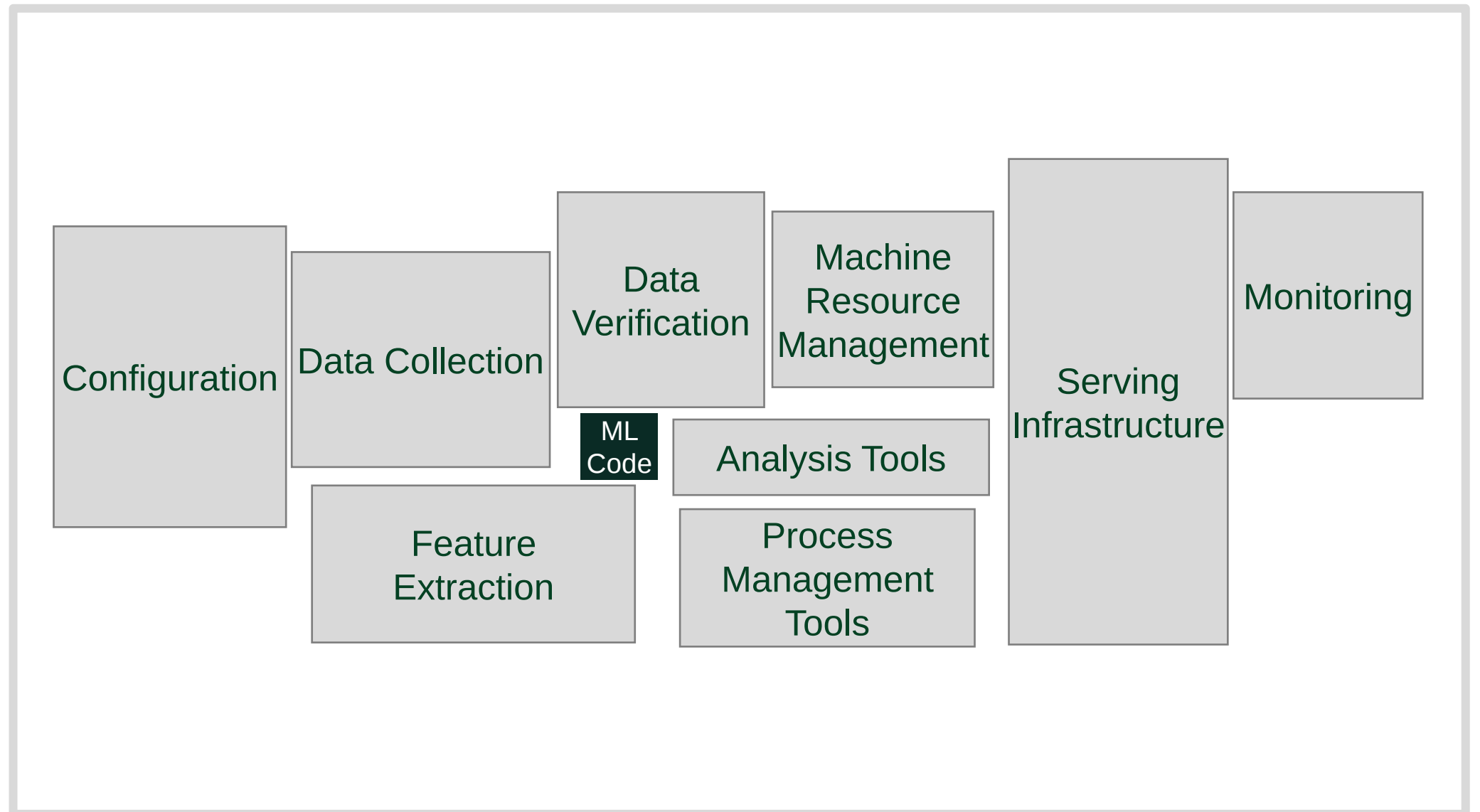
- **Ongoing validation**
Production models need to be validated all the time
- **Ongoing data collection**
Data collection becomes an ongoing concern
- **Technical debt**
Data scientists end up spending time monitoring “old” projects instead of investing in new ones

Adapt

- **Stale models**
Production changes inevitably cause models to go stale
- **Human-in-the-loop**
Users need to review the results of a model and provide feedback to fine-tune it
- **Relearning**
Model relearning is often manual

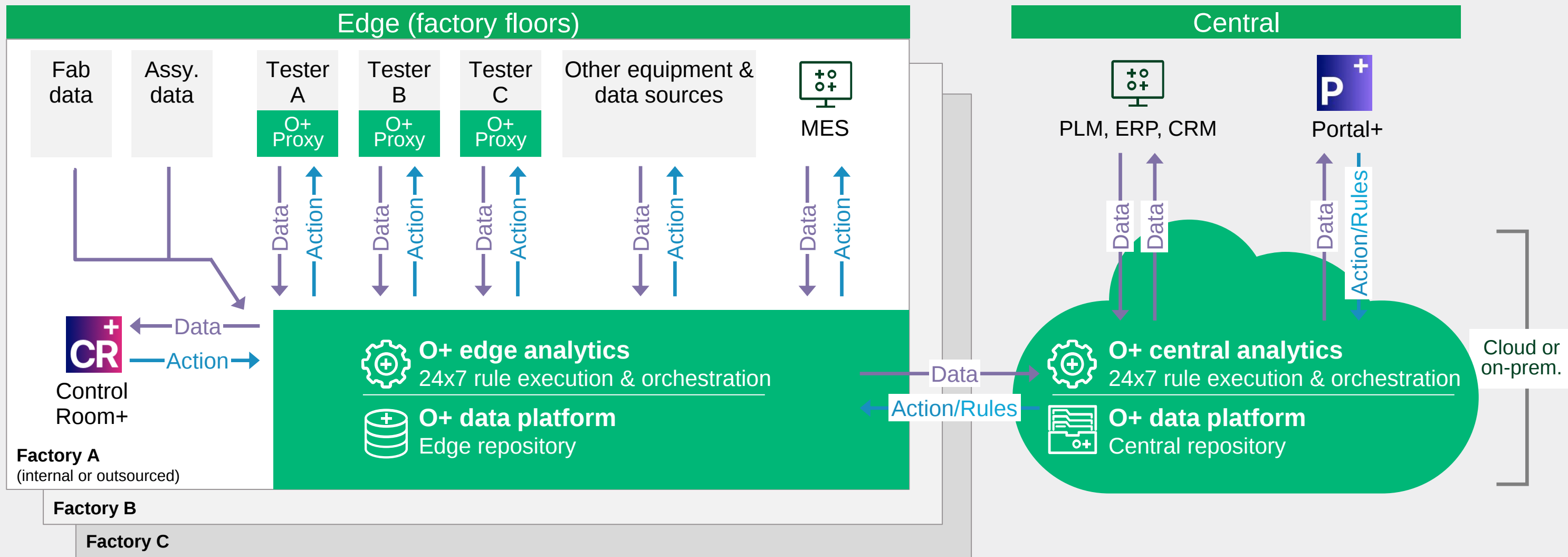
Hidden Complexity – the Google View

It's all
about the
infrastructure



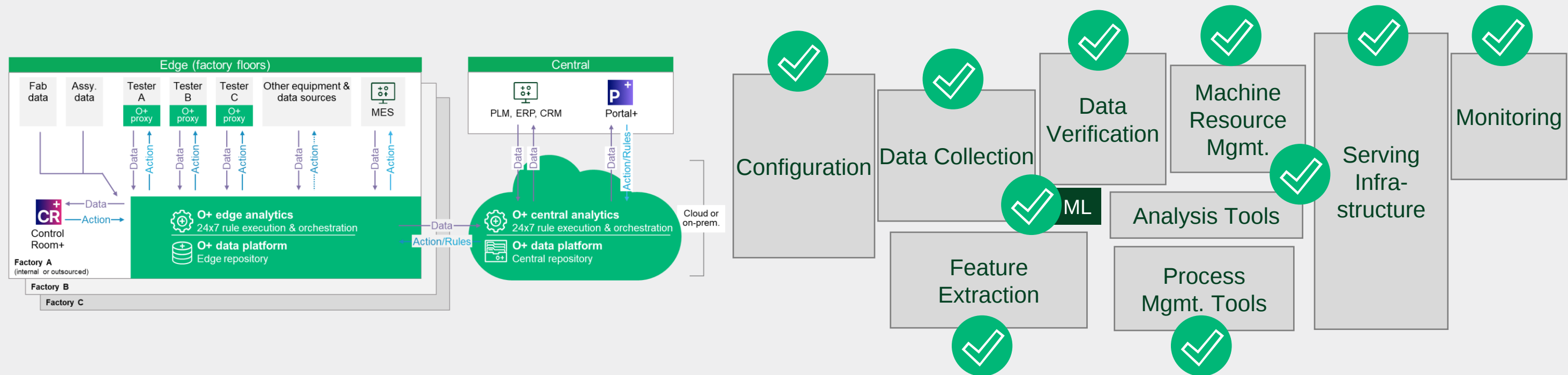
Source: Google article from 2014: Hidden Technical Debt in Machine Learning Systems
<https://papers.nips.cc/paper/5656-hidden-technical-debt-in-machine-learning-systems.pdf>

Global Operations – “GO” – Architecture



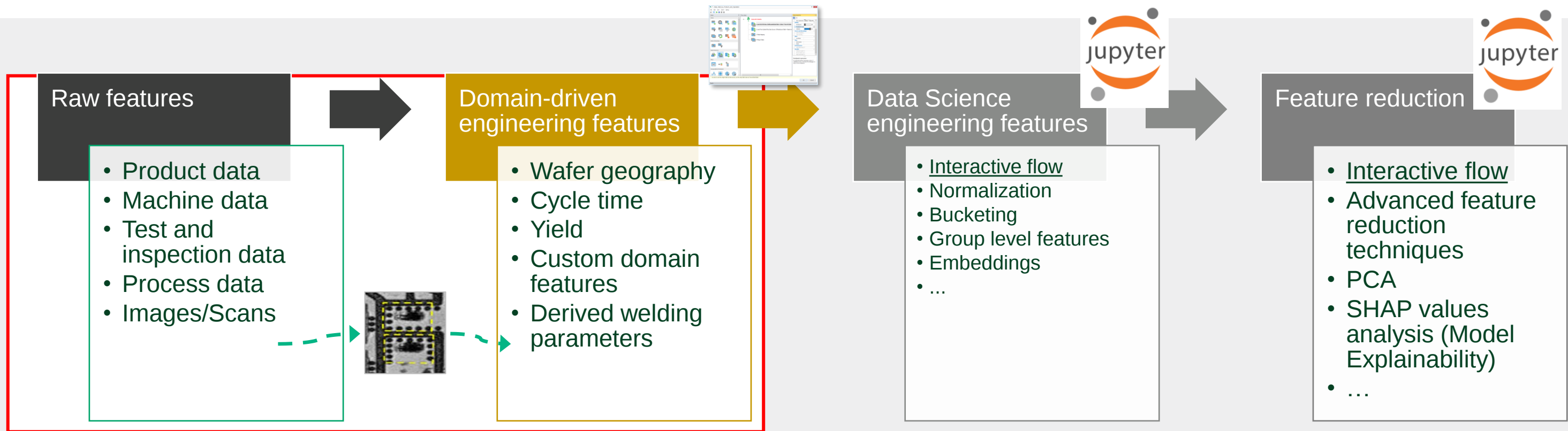
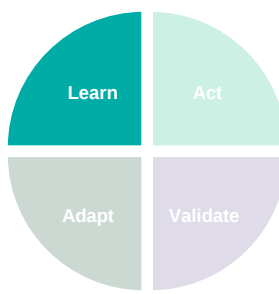
Actionable insights across all manufacturing and test processes

Optimal+ GO – Comprehensive ML Operations

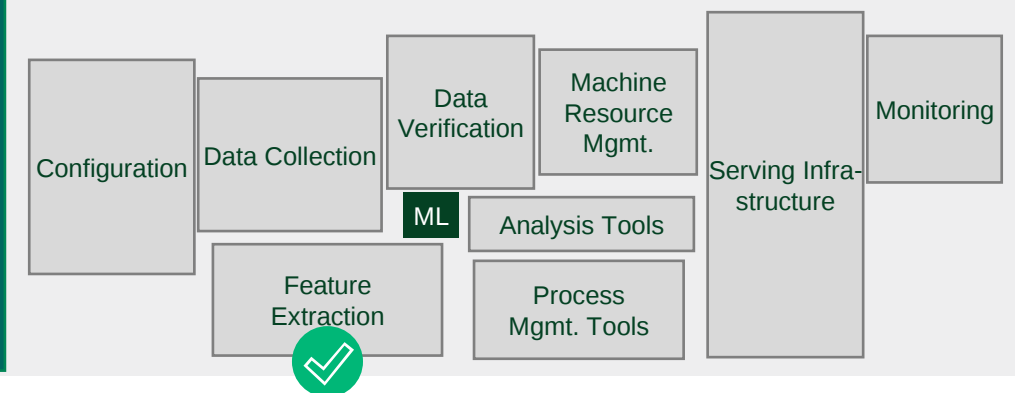


Optimal+ covers the full scope all the way through ML deployment

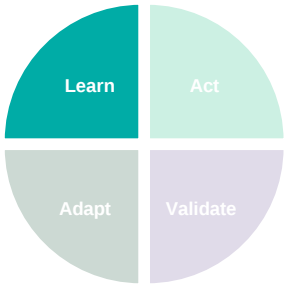
Feature Extraction



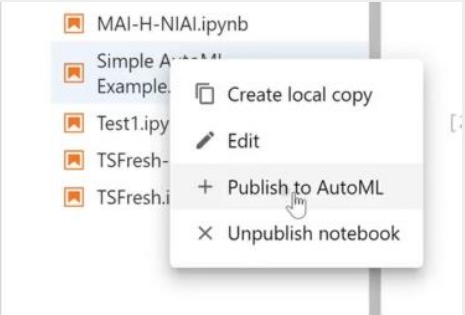
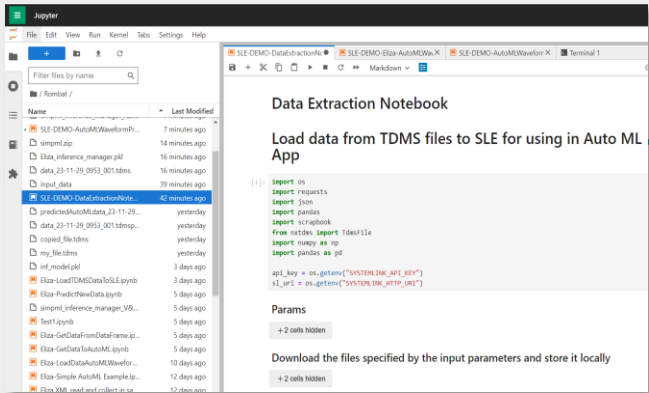
Engineering features benefit ML models but require domain expertise. The platform saves time by contextualizing data into ML-ready datasets and calculating domain-specific features.



AutoML

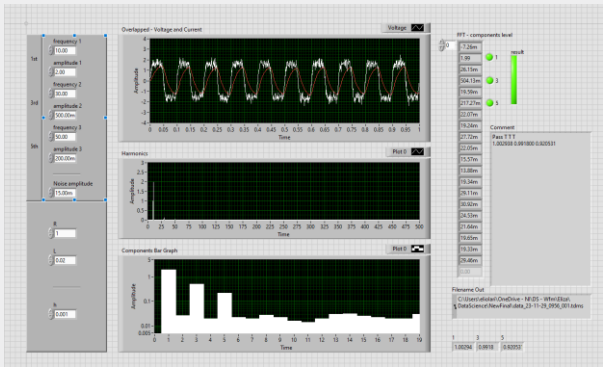
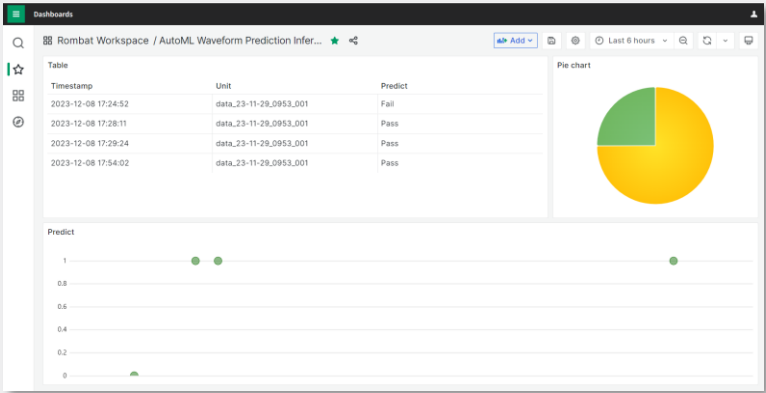


Data Extraction Notebook

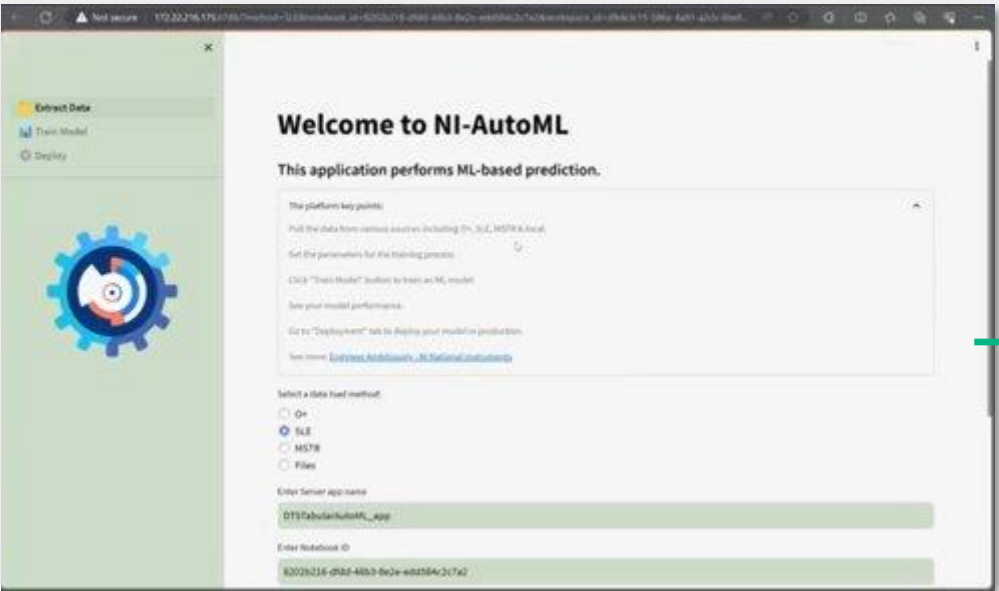


Open AutoML

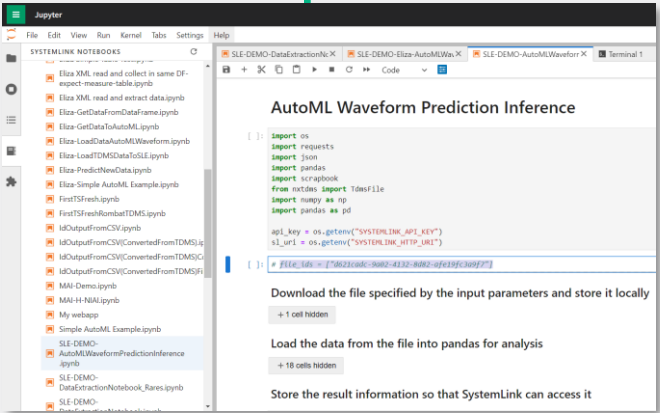
AutoML Deploys Model



Generate Data

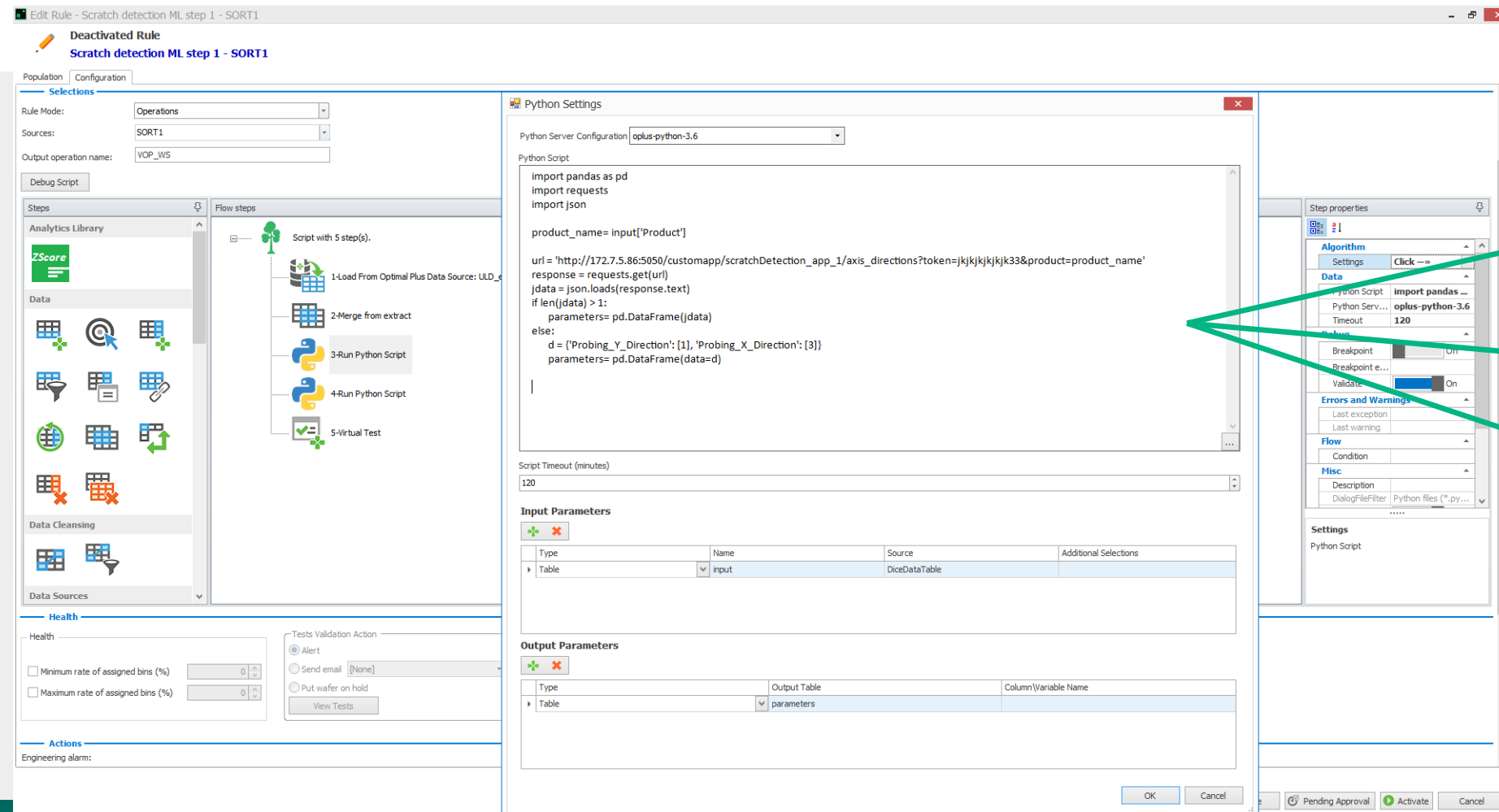
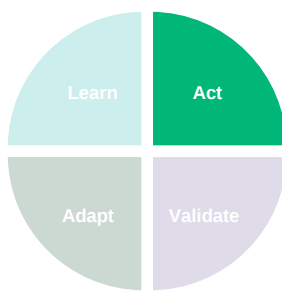


AutoML Train Models

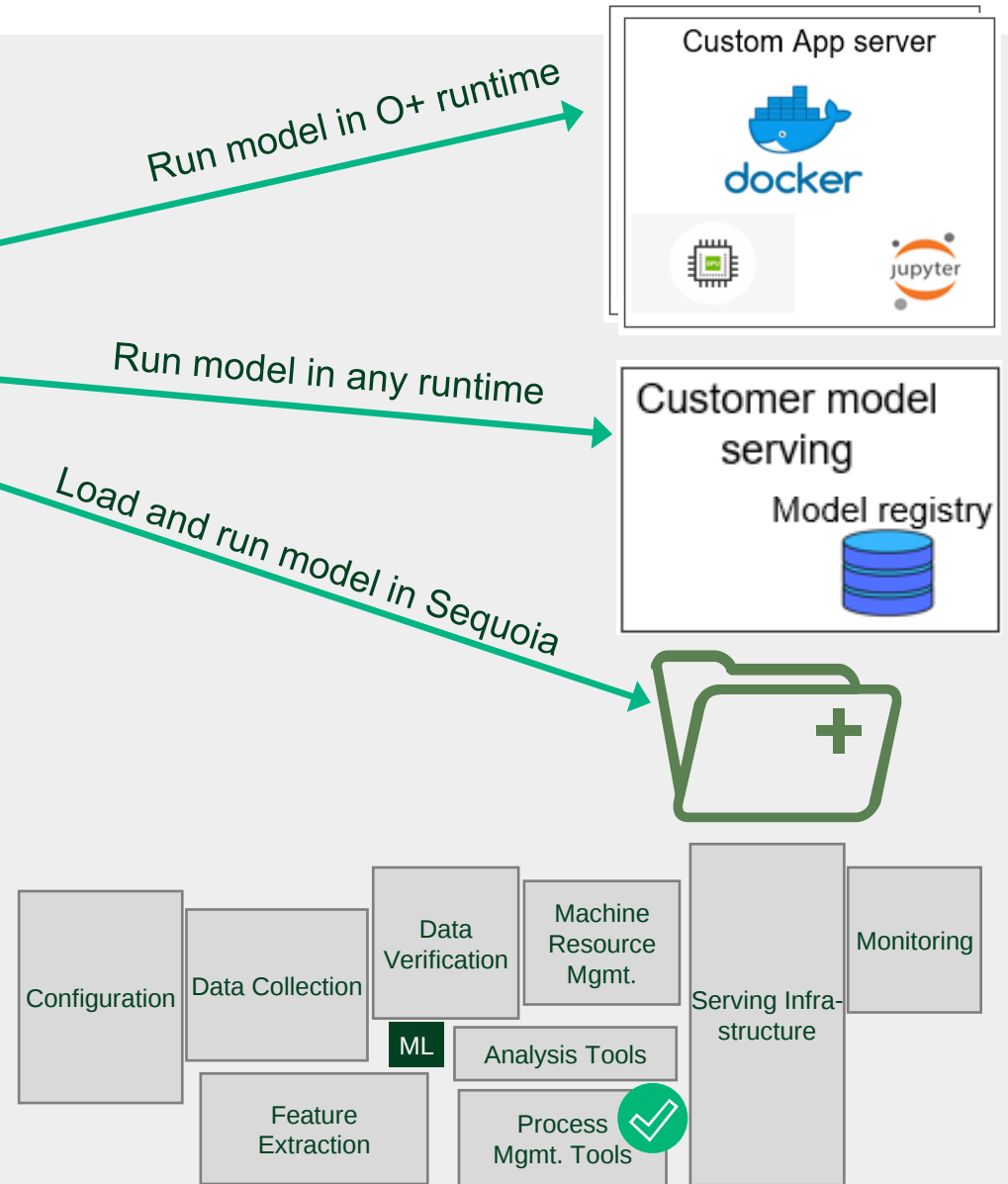


AutoML-based prediction Notebook

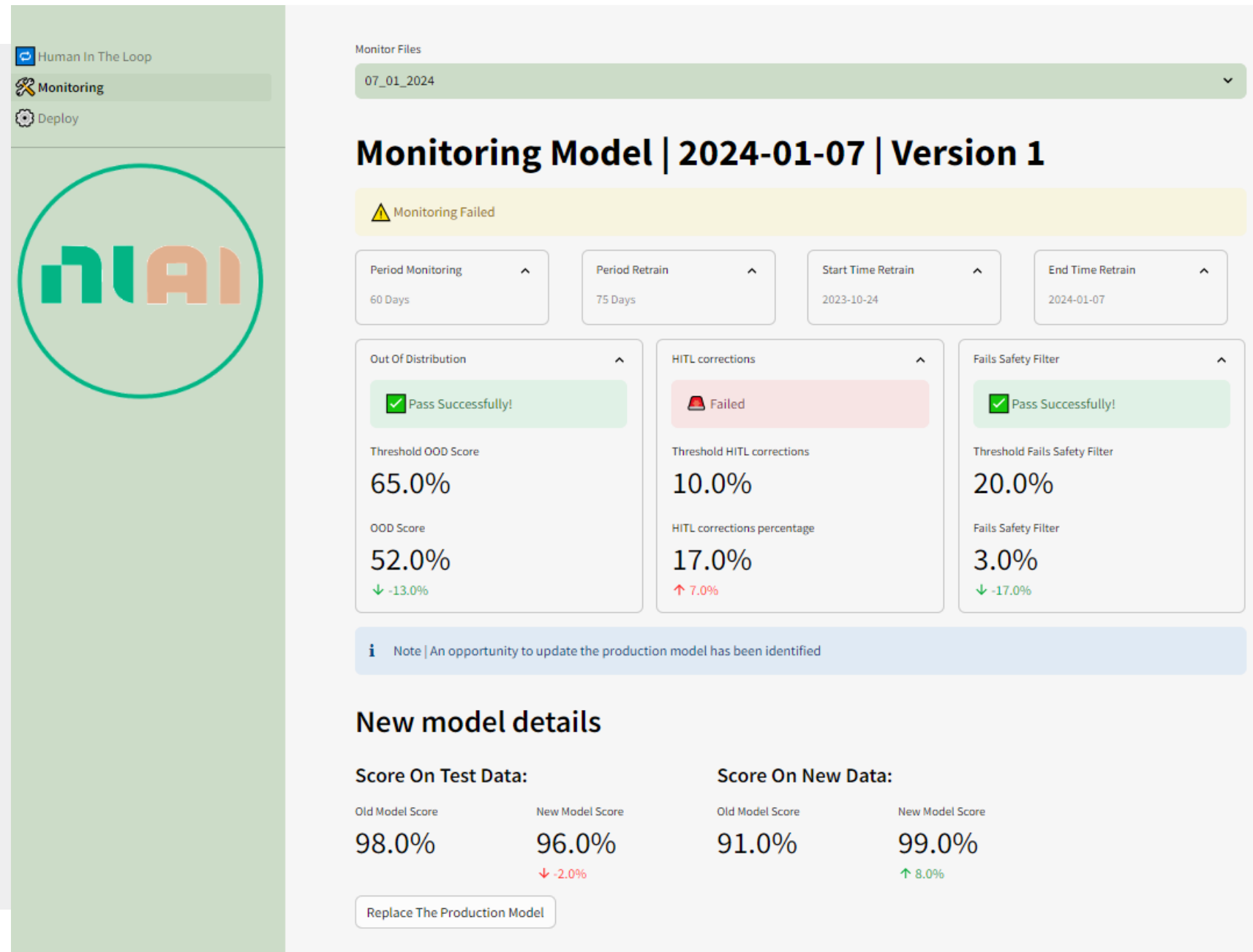
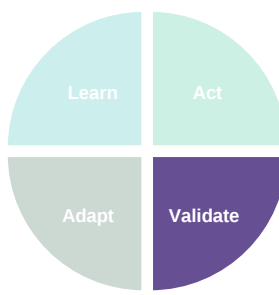
Edge Inferencing using Rules



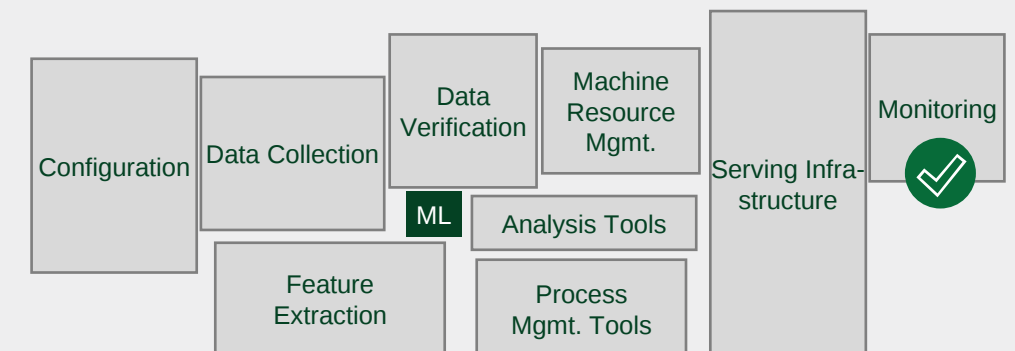
- Rules trigger model inference at the right time with the right data
- Feature engineering utilizes Sequoia reusable automation
- Flexible options for model execution runtime



Monitoring an AutoML App

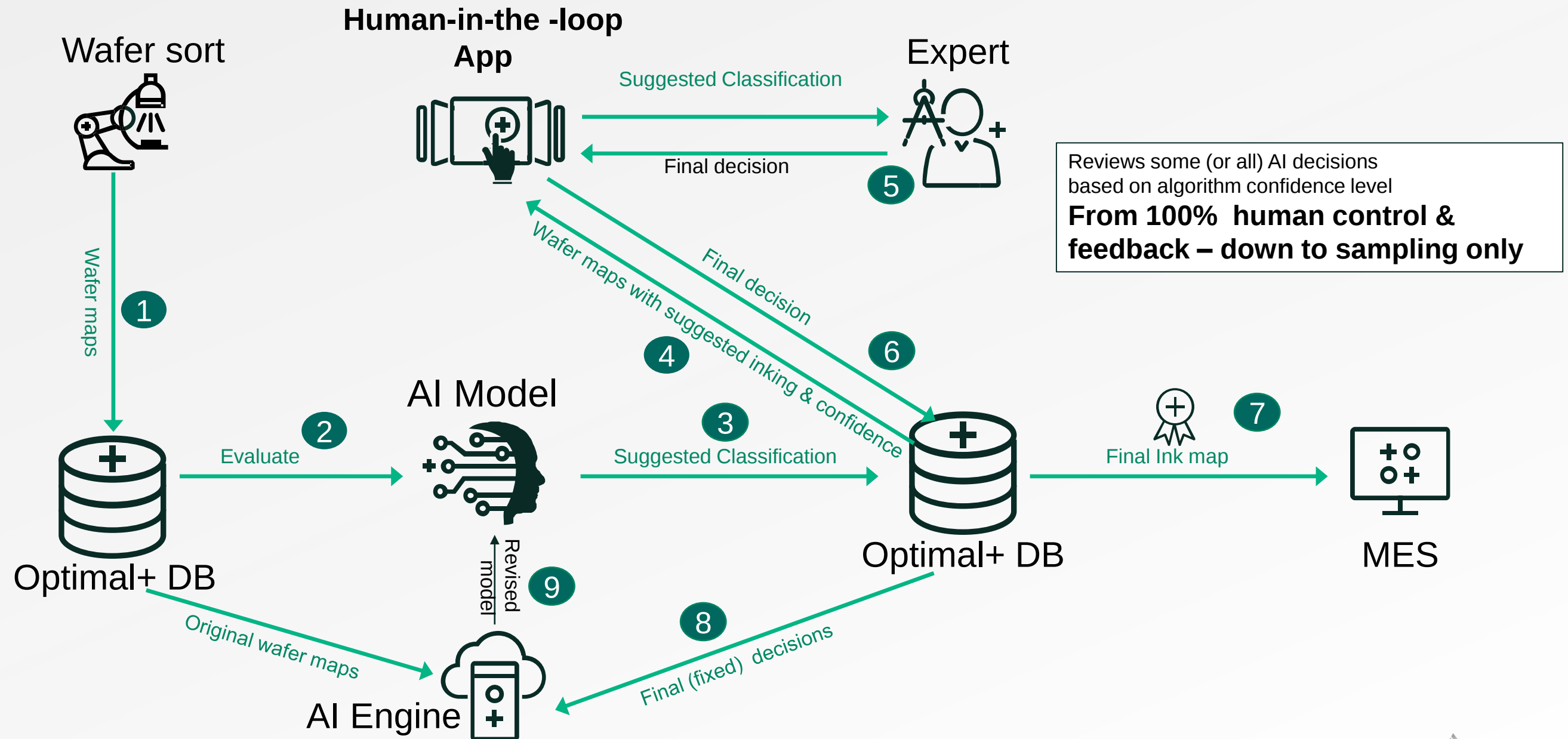
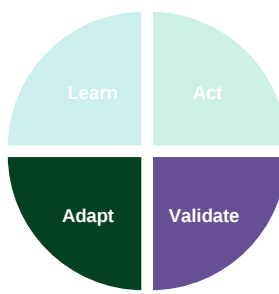


- Automatically identify deteriorating model results
- Relearn on latest data to improve model

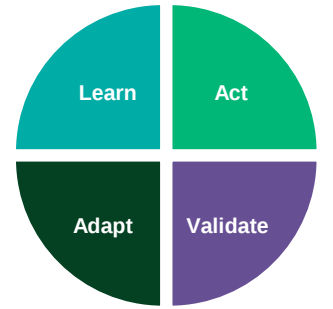


Human-in-the-Loop

Improve model while gaining user confidence



The Full Machine Learning Lifecycle



Learn

- **Getting data**
Data is collected and harmonized all the time, making it available at the click of a button
- **Feature extraction**
Advanced features are extracted via out-of-the-box capabilities (e.g. geographic and parametric outliers)
- **Freedom of choice**
Full support for data science platforms

Act

- **Complex “plumbing”**
Plumbing is handled under the hood by the Optimal+ infrastructure
- **Actionability**
Integration with equipment and systems is part of the Optimal+ deployment
- **Distributed mfg.**
Optimal+ is deployed across the entire mfg. ecosystem – internal and outsourced

Validate

- **Ongoing validation**
Standard rules monitor ML models for excursions
- **Ongoing data collection**
Data collection and harmonization is already fully automatic
- **Technical debt**
24x7 monitoring frees data scientists for their next project

Adapt

- **Stale models**
Automated rules detect when models are going stale and can even disable them if needed
- **Human-in-the-loop**
Users can browse results and provide feedback directly
- **Relearning**
Model relearning can be partially or fully automated

What's Next for AI at the Edge

NI Global Operations

Real-time Application Enablement Layer (DIY & Canned models)

ADVANTEST

Edge, Nexus, &
ACS

TERADYNE

UltraEDGE &
Archimedes



(standalone)

Test Floors

Testers

Test throughput, speed, and consistency



Real-Time Execution

Edge Servers

Data ingestion, monitoring and action control

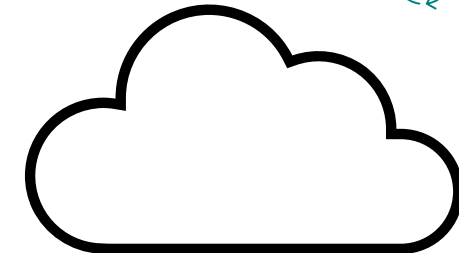
Model Execution



Central

Big data observability, insights and model creation

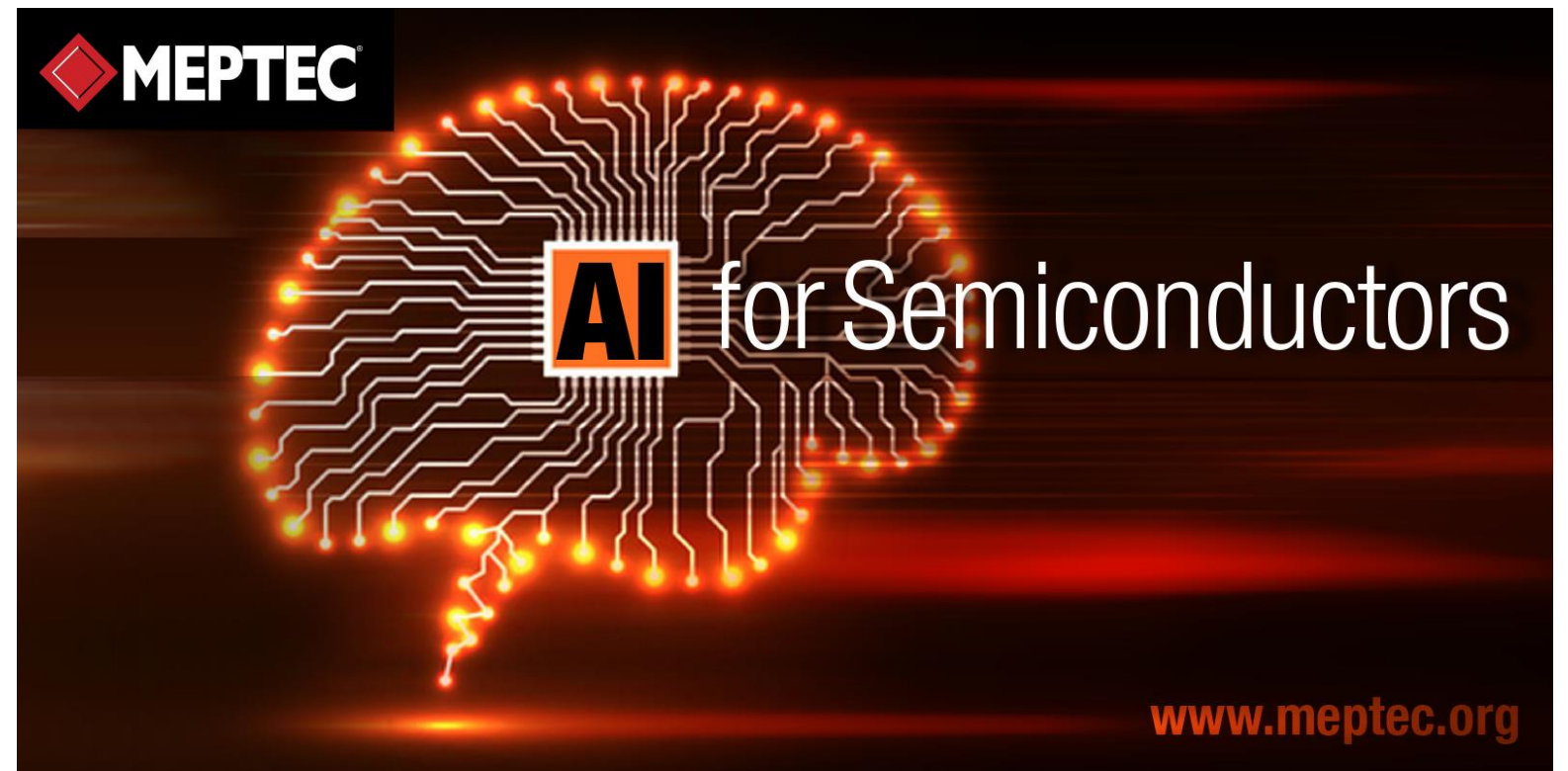
Model Execution



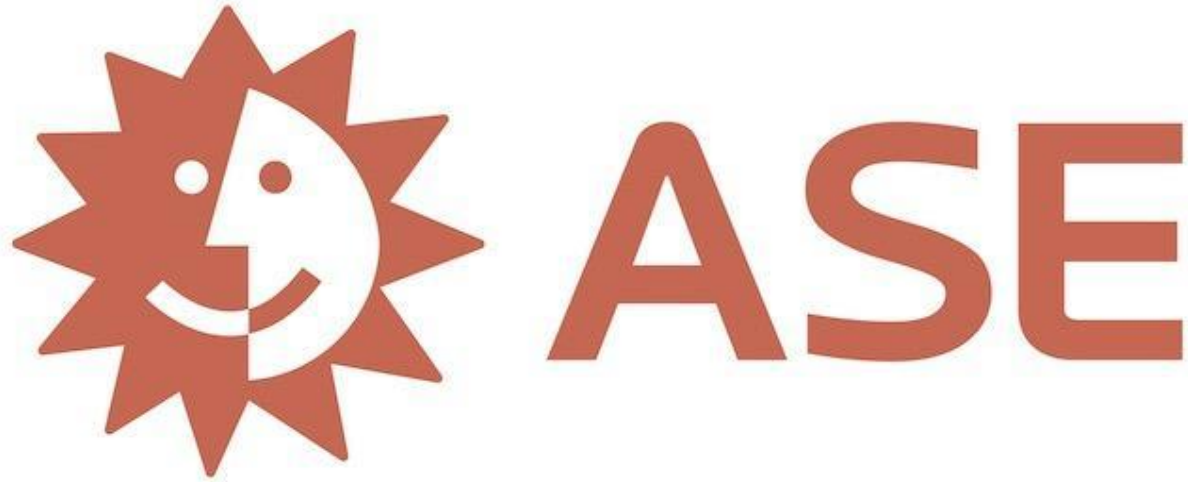
Data, Models, Actions, Monitoring, Etc.

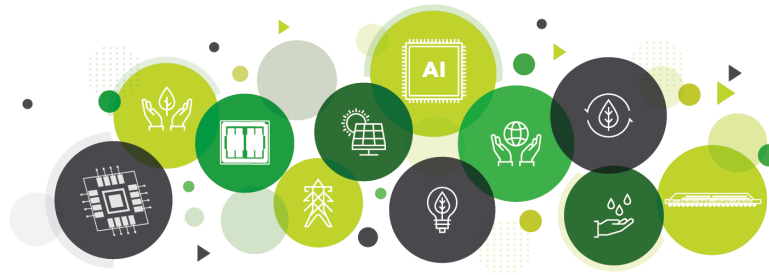


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